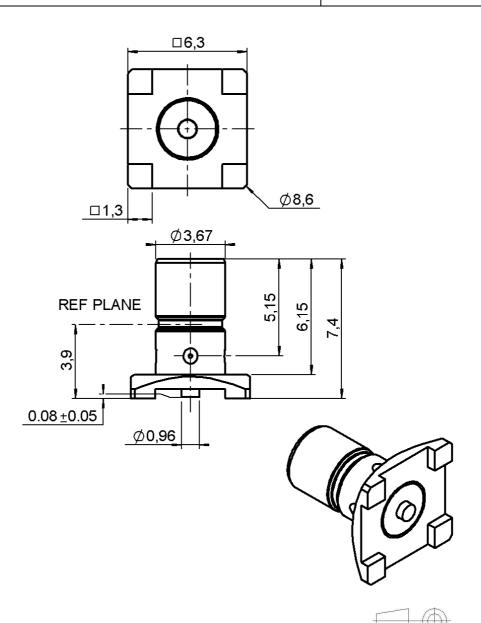
MALE STRAIGHT RECEPTACLE FOR PCB **SMT TYPE- REEL OF 500**

Series : SMB

R114.424.030





All dimensions are in mm.

 COMPONENTS	MATERIALS	PLATINGS (μm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	BRASS BRASS - PTFE	GOLD 0.5 OVER NICKEL 2 GOLD 0.2 OVER NICKEL 2

Issue: 0847 B

In the effort to improve our products, we reserve the right to make changes judged to be



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PACKAGING

Standard Unit Other 500 'W' option Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance $\mathbf{50} \Omega$

Frequency **0-4** GHz VSWR **1.05** * + **0,0080** x F(GHz) Maxi

Insertion loss $0.03*\sqrt{F(GHz)}$ dB Maxi RF leakage -(57-F(GHz)) dB Maxi

Voltage rating S00 Veff Maxi Dielectric withstanding voltage Insulation resistance S00 Veff mini 1000 M Ω mini

ENVIRONMENTAL

Operating temperature -65/+165 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

* Coaxial Transmission Line Only

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

10 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini

Weight **0,4830** g

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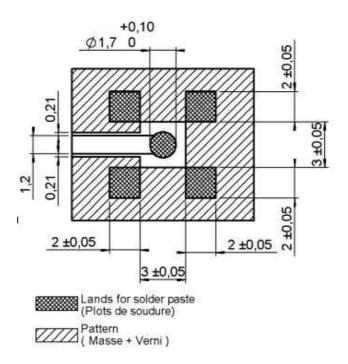
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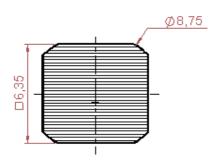
SMB SERIES – INFORMATION

Coplanar line: pattern and signal are on the same side. Thickness of PCB: 1.6 mm

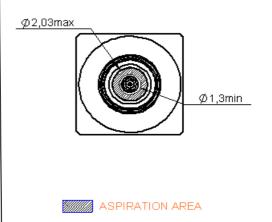
The material of PCB is the epoxy resin of glass fabrics bacs. (Er=4.8). The solder resist should be printed exept for the land pattern on the PCB.



SHADOW OF SMB RECEPTACLE FOR VIDEO CAMERA



ASRIRATION AREA



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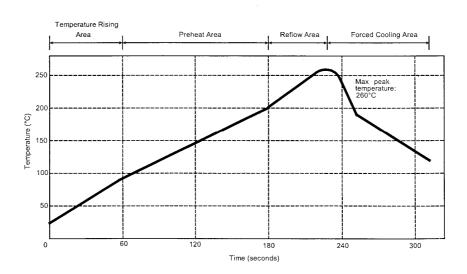
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SOLDER PROCEDURE

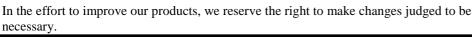
- 1. Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
- 3. Soldering by infra-red reflow.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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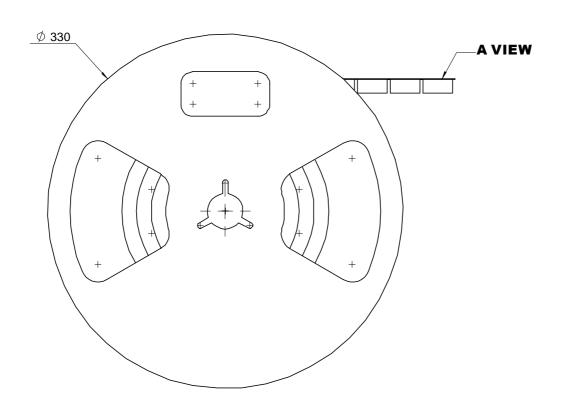




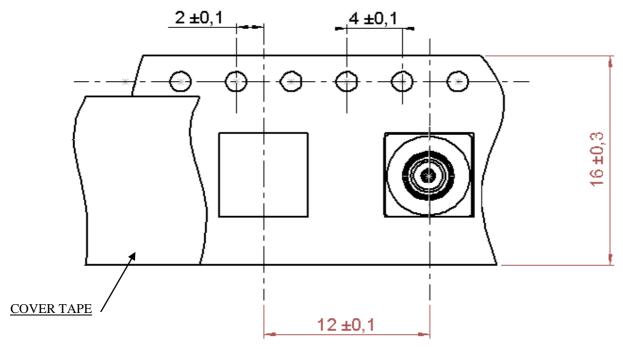
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A VIEW (Scale 3)



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